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Patent

JAN 22 2006Customer No.: 31561
Application No.: 10/707,686
Docket No. 11844-US-PA**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Applicants : Chen et al.
Application No. : 10/707,686
Filed : January 5, 2004
For : CHIP PACKAGE STRUCTURE
Art Unit : 2891
Examiner : THAI, LUAN C.

TRANSMITTAL LETTER

+1-571-273-8300

(Via fax: 1+2+12 pages)

ASSISTANT COMMISSIONER FOR PATENTS
Alexandria, VA 22314

Dear Sir,

In response to the Advisory Action dated January 6, 2006, please find the relevant papers as follows:

- ☒ Request for Continued Examination in (2) pages;
- ☒ Preliminary Amendment in (12) pages

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property OfficeDate: Jan. 20, 2006By: Belinda Lee
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